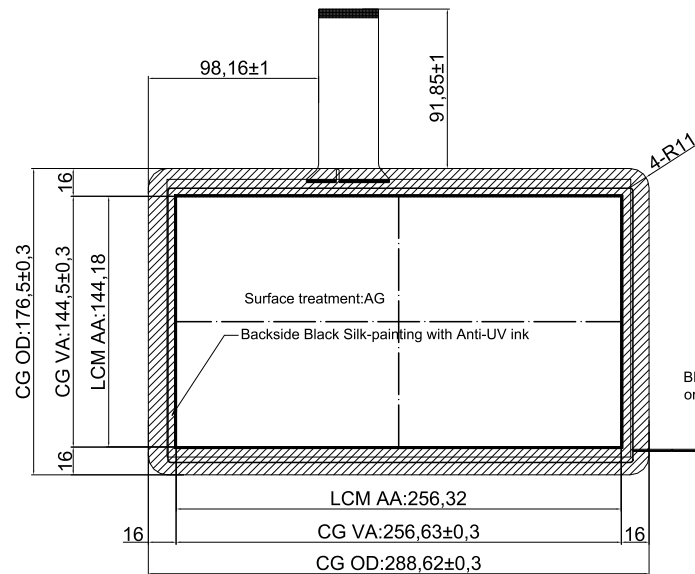


Ver.	Modify No.	Details	Area	P.I.C	Date
01	02	CG OD is changed to 288.62*176.5mm, CG thickness is changed to 1.8mm, AG treatment is increased, EMI is increased	DWG	Curry	250111

Front view

Side view

Back view



BHSR-02VS-1
or equivalent

C0.3±0.2

TOTAL: 8.3±0.8

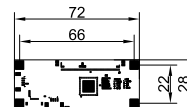
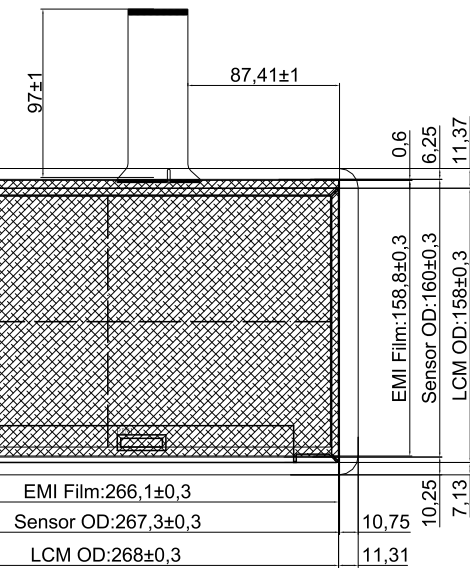
CG: 1.8±0.2
SCA-AC: 0.2
Sensor: 0.7
EMI Film: 0.3
OCA: 0.2
LCM: 5.1(max)

L=175±10

0.6

10.57

9.32



Technical Datasheet:

1. Structure: TP+EMI+LCM Optical Bonding
2. Cover Glass: T=1.8mm Tempered glass
3. LCD: 116HWV-EA7-BL1K
4. TP Controller: BTP-TPM-CTR-ILI-116B-SN04
5. TP Controller IC: ILI2511
6. Surface Hardness: ≥6H
7. Light Transmittance: ≥85%
8. Working Temperature: -20℃~+70℃, ≤85%RH;
9. Storage Temperature: -30℃~+80℃, ≤85%RH;
10. Unmarked Tolerance: ±0.3mm
11. All materials used conform to RoHS standards

Part No.		BTP-TPM-RC-11.6-ILI-SN04			
Product Name: 11.6 inch Touch Display (TP+LCM Optial Bonding)		Drawing No.		PM116250109SN04	
		Project Code.		PM116SN04	
Business Unit: SNT-BTP		Period Mark		View Angle	Ratio
		A			1:1
BOM Code		2.03.116.01.0104		Page 1	
Product Series		BTP-TPM		Total 1 Page	
		 思诺泰科电子(苏州)有限公司 SINOTRONICS INC.			